
**OCTOBER
2006**

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Meeting**

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Review**

**Be sure to visit our section
website:**

<http://www.asq0905.org>

Section 0905 Mission Statement

The mission of Section 0905 is to develop and provide a strong organization for exchanging knowledge and ideas necessary for the growth and development of quality professionals in a manner that benefits the membership, business, and the Northeast Indiana Community.

Mailing Address:

**American Society for Quality
Northeastern Indiana Section 0905
P.O. Box 11887
Fort Wayne, Indiana 46861-1887**

The Histogram

N e w s l e t t e r

**There will be no Dinner Meeting in November due to the
Lean Six Sigma Excellence Conference on the 16th.**



**THE POWER OF LEAN SIX SIGMA
& LEAN IS UNDENIABLE.**
Organizations are reaping significant tangible
benefits and achieving irrefutable success.

KEYNOTE SPEAKER:
Keynote speaker, Scott Lasater—who has been known at
GE for the past decade as the guy who taught Jack Welch
Six Sigma—will inspire, challenge and entertain you.

CO-HOSTED BY:



Go to www.tqmconferences.com or call 260-627-8139 to register.

Excellence Conference

This month instead of our normal "dinner meeting" we are pleased that we are able to co-host the Excellence Conference at the Memorial Coliseum. Support your local section and attend this all-day conference.

To register, go to

www.tqmconferences.com

We will use any profits from this conference to provide scholarships to deserving students. It's a win-win situation. You get valuable information about Lean and 6 Sigma and students get help with their tuition.

This year we will feature 25 sessions led by experienced innovative industry leaders who will guide you through:

- Proactively preparing for challenges in deploying Lean Six Sigma scientific process improvement methodologies
- Developing a culture of innovators and problem solvers
- Aligning actions with strategy
- Empowering the transformation process
- Generating significant improvements
- Avoiding common pitfalls and mistakes in implementation
- ASQ Leadership from Wilwaukee will be presenting information about ECQ

I attended last year's conference. Between learning, networking, making new friends, eating wonderful food, and listening to leaders in our community, the day flew by.

Can't wait until this year's conference! Register now for the *Fourth Annual Six Sigma Excellence Conference* on November 16, 2006. It's your career...**BE THERE!**

Recertification Contact Person

Mr. Chuck Bandelier
3543 E. Arabian Drive
Columbia City, IN 46725
260-429-5774
bandel@netusa1.net

The importance of maintaining the currency of your hard-earned certifications by using continuing education credits or other acceptable credits can not be over stated. Do not send recertification paperwork to the Section's mailing address, as the timeliness of your recertification may be lost. Paperwork should be sent directly to Chuck. If you have any questions about the material required to verify your recertification, call Chuck. remember the other way to retain your certification is to simply retest. I don't know anyone who wants that option.

Interested in advertising in the Histogram? The Histogram is published from September thru May. The charge is as follows:

1/4 page advertisement \$25.00/each month

1/2 page advertisement \$50.00/each month

Whole page advertisement \$100.00/each month

Contact Leslie Zody at 260-244-2114 or leslie.zody@autoliv.com for more details.

SCHOLARSHIP TIME

It is scholarship time again! This year the Northeastern Indiana ASQ section 0905 will again be awarding scholarships to deserving individuals. These scholarships will be awarded on criteria including enrollment in a qualifying major, grade point average, financial need, extra curricular activities, and presentation of the application. Applications and official transcripts must be received by February 1, 2007. The scholarships will be awarded during the March meeting. A copy of the application is included on the next page.

**ASQ SECTION 0905
SCHOLARSHIP APPLICATION
DEADLINE FOR SUBMITTING: (FEBRUARY 1 OF AWARD YEAR)
MAIL TO:
Milt Gallmeyer, SCHOLARSHIP CHAIRMAN
6548E 1000N
Ossian, IN 46777
Email: mgallmeyer@generalaluminum.com**

1. MEMBER'S NAME _____

LAST	FIRST	MIDDLE
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 ADDRESS _____
 CITY _____ STATE _____ ZIP CODE _____
2. NUMBER OF YEARS OF ASQ MEMBERSHIP _____
3. STUDENT NAME _____

LAST	FIRST	MIDDLE
------	-------	--------

 ADDRESS _____
 CITY _____ STATE _____ ZIP CODE _____
4. UNIVERSITY ATTENDING _____
5. CLASS STANDING CHECK ONE: ___ SO ___ JR ___ SR
6. NAME OF DEGREE PROGRAM _____
7. HOURS COMPLETED* _____ SCHOLASTIC AVERAGE _____
PLEASE ATTACH LATEST OFFICIAL COLLEGE TRANSCRIPT (REQUIRED)-2.70/4.0 MIN. REQ.
8. I WOULD LIKE TO RECEIVE THE SCHOLARSHIP BECAUSE (INDICATE NEED) _____

9. LIST ALL OTHER SCHOLARSHIPS AND AID YOU WILL RECEIVE FOR THE ACADEMIC YEAR

10. UNIVERSITY EXTRACURRICULAR/COMMUNITY ACTIVITIES (PLEASE LIST) _____

ELIGIBILITY for one annual \$800 renewable scholarship (Limit of three)

1. Must be sponsored by an active ASQ Section 0905 member in good standing, and have completed one academic year * prior to the applicable date and who will be a full time student (12 sem. hrs. or more) during award use.
2. Must be enrolled in a program leading to an Associate, or Bachelors degree in Engineering, Technology, Physical or Natural Sciences, Mathematics, Statistics, Business-Administration., Health Sciences, and Education at a recognized (ABET or equiv. accredited) college or university.

*** (30 Sem. hrs. or 45 Qtr. hrs. minimum)**

APPLICANT'S SIGNATURE _____

DATE _____

NOTE: Winner selection will be made at the February Board meeting.
NOTE: SCHOLARSHIP WILL BE AWARDED DURING THE REGULARLY SCHEDULED MARCH MEETING
 (Rev.10-10-06)

Recap of October Meeting

At the Thursday evening dinner meeting at Halls, David Herrick did a great job introducing us to Adhesives and Sealants made by Henkel Loctite. He presented information on

1. Basic joint design
2. Considerations when designing with adhesives - open time, viscosity, single or two component chemistry, chemical attack to substrate, gap fill, etc.
3. Selection Criteria - speed, durability, heat resistance, chemical/environmental conditions, uncured, curing and cured states of adhesive, etc.
4. Adhesive technology review - cyanoacrylates (superglue), structural acrylics, epoxy, urethane, hot melt, light cure and silicone chemistries.
5. Dispensing equipment.

He had samples and literature available for those present.

I have had first hand experience dealing with Henkel Loctite representatives on a number of occasions. They have always exceeded my expectations.

If you have any questions related to the subject I encourage you to contact:

David Herrick
Adhesives and Sealants Specialist
Henkel Loctite
david.herrick@us.henkel.com
Cell: 260-433-5064
Office: 260-492-955
Fax: 260-492-9565
Voice Mail: 800-562-8483, voice mail box 6329

If you are interested in an in-house seminar related to your particular needs, David has provided an "ON-SITE TECHNOLOGY SEMINAR" form to help in identifying your specific needs. (On the next page)



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ON-SITE TECHNOLOGY SEMINAR

Your company has indicated interest in a **Loctite OEM Adhesive Seminar** to be conducted in your facility. In order to tailor the presentation to your needs please complete the survey below.

Please rank the following areas of discussion:

5 = Most Important

1 = Least Important

___ Key Considerations When Designing with Adhesives (Adhesives vs. Other Joining/Assembly Methods)

___ Loctite Adhesive Technology — (Discuss All Loctite Available Technologies)

OR Discuss Only These:

___ Acrylics

___ Instant Adhesives

___ Epoxies/Polyurethanes

___ Hot Melt Adhesives

___ Light Cure Technologies

___ Silicones

___ Substrate/Adhesive Selection (How to Select Optimal Substrate/Adhesive Combinations)

___ Joint Design (How To Optimize Adhesive Joints and Avoid Poor Design)

___ Key Selection Criteria (Consideration of Uncured, Curing, and Cured Properties)

___ Processing Equipment (Dispensing Valves, Pressure Vessels and Controllers plus, UV Curing Equipment)



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